

PLANO EXPO

EMPRESAS EXPOSITORAS

- ACEE
- Aerotech
- AMF Impresores
- Antalis
- Armor Group
- ASA System
- AS Consultores
- Austral Chemical
- Auxiliar Conservera
- Ball
- BASF
- Borealis
- Cadec
- Cadegroup
- CAMCHAL
- CENEM
- CeTA
- CMPC
- Codaprint
- Coexpan
- COIM (BDO)
- COLBUN
- Condensa
- Cristal Chile
- Crival
- DAS8
- Dipisa
- Eco-lógica
- Edelpa
- Empack
- Envases Aguila
- Epson
- Ferrostaal
- FibroMás
- Flint Group
- FoodPack
- Fosko
- Fulltrading
- Geociclos
- GrafiSoft
- Gualapack
- Hagraf
- HP
- ICY
- Idea-Tec
- Imagex
- Imicar
- Incutools
- In Flex
- Jowat
- Kuraray
- LatinPack - Arma
- Marienberg
- Marvi
- MM Packaging
- Morgan Impresores
- Ocex Peru
- Oxiquim
- Packaging Consulting
- Packaging Services
- Packaging Xpert
- Papelera Dimar
- Parnaplast
- Patel
- Petark
- Phoenix
- Prisma Analitica
- Procer
- ProChile
- Quimatic
- RCM-Nordson
- Reclay
- Red&Blue
- Rigm
- Robatech
- San Jorge Packaging
- Siegwark
- Technofilm
- Tesa
- Slow Santiago
- Snetor Francia
- Solunion Chile
- Sun Chemical
- Tavail - España
- Tesa Tape
- Toyoink
- Transforma Alimentos
- Tiemsa
- UDD
- USACH
- VAI - agua
- Veolia
- Vitopel Argentina
- Walbaum
- Winkler

